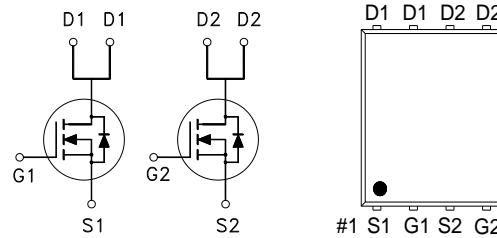


NIKO-SEM
**Dual N-Channel Enhancement Mode
Field Effect Transistor**
P3606HK
PDFN 5x6P
Halogen-Free & Lead-Free
PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
60V	38mΩ	15A


G. GATE
D. DRAIN
S. SOURCE
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current ³	$T_C = 25^\circ\text{C}$	I_D	15	A
	$T_C = 100^\circ\text{C}$		10	
Pulsed Drain Current ¹		I_{DM}	40	
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	5	A
	$T_A = 70^\circ\text{C}$		4	
Avalanche Current		I_{AS}	18.6	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	17.3	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	20.8	W
	$T_C = 100^\circ\text{C}$		8	
Power Dissipation	$T_A = 25^\circ\text{C}$	P_D	2.3	W
	$T_A = 70^\circ\text{C}$		1.5	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$R_{\theta JA}$		55	°C / W
Junction-to-Case	$R_{\theta JC}$		6	

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	60			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.3	1.8	2.3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48V, V _{GS} = 0V			1	
		V _{DS} = 40V, V _{GS} = 0V, T _J = 55 °C			10	μA
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 5A		36	47	
		V _{GS} = 10V, I _D = 5A		33	38	mΩ
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 5A		29		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz		541		
Output Capacitance	C _{oss}			75		pF
Reverse Transfer Capacitance	C _{rss}			45		
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		1.3		Ω
Total Gate Charge ²	Q _g	V _{GS} = 10V		13.3		
		V _{GS} = 4.5V		7.7		
Gate-Source Charge ²	Q _{gs}	V _{DS} = 30V, I _D = 5A		1.7		nC
Gate-Drain Charge ²	Q _{gd}			4.6		
Turn-On Delay Time ²	t _{d(on)}			16		
Rise Time ²	t _r			10		
Turn-Off Delay Time ²	t _{d(off)}	V _{DS} = 30V , I _D ≈ 5A, V _{GS} = 10V, R _{GEN} = 6Ω		34		nS
Fall Time ²	t _f			10		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current ³	I _S				15	A
Forward Voltage ¹	V _{SD}	I _F = 5A, V _{GS} = 0V			1.3	V
Reverse Recovery Time	t _{rr}	I _F = 5A, dI _F /dt = 100A / μS		14.6		nS
Reverse Recovery Charge	Q _{rr}			5		nC

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

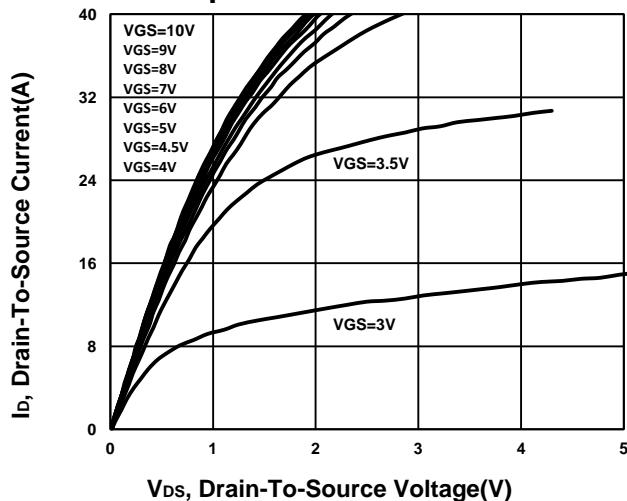
²Independent of operating temperature.

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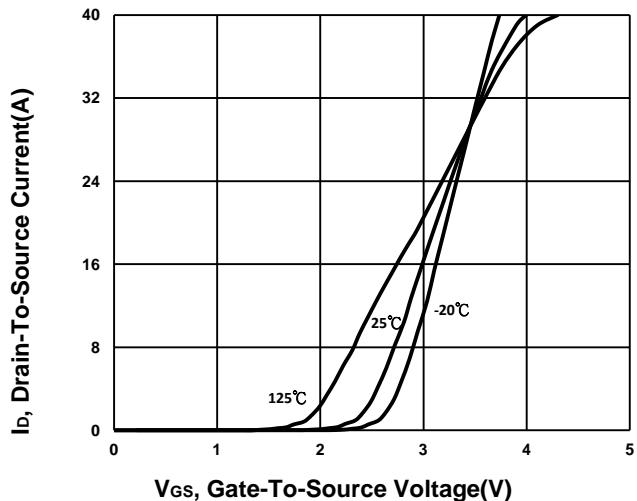
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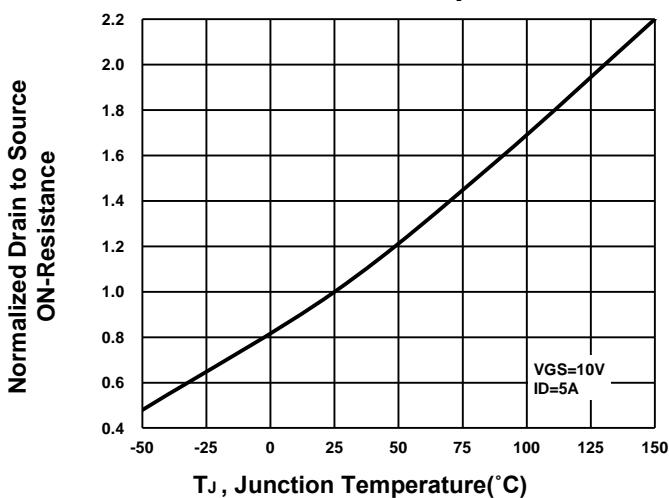
Output Characteristics



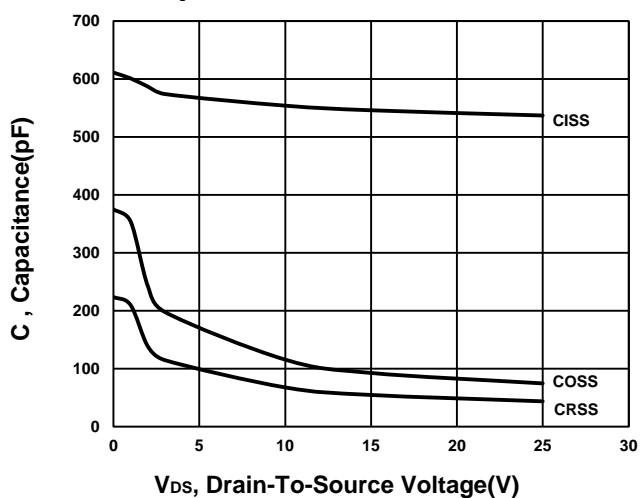
Transfer Characteristics



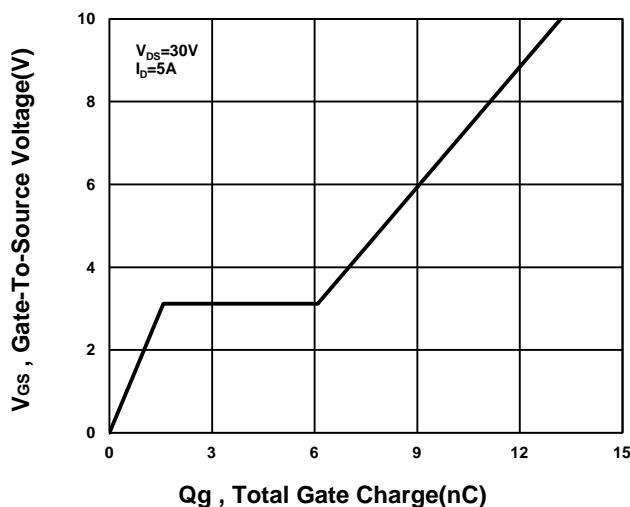
On-Resistance VS Temperature



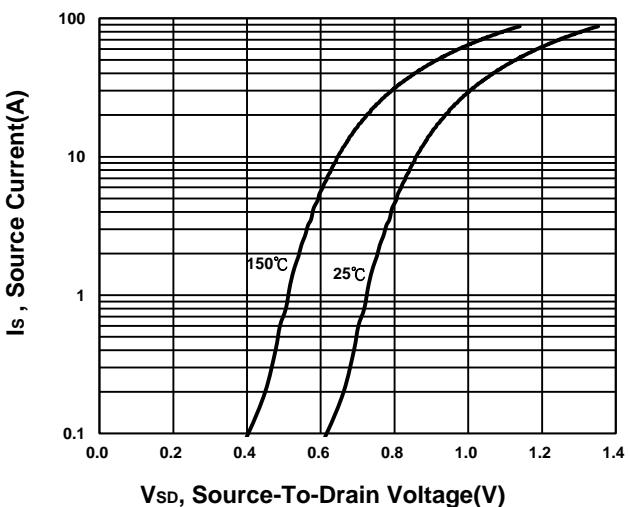
Capacitance Characteristic



Gate charge Characteristics



Source-Drain Diode Forward Voltage

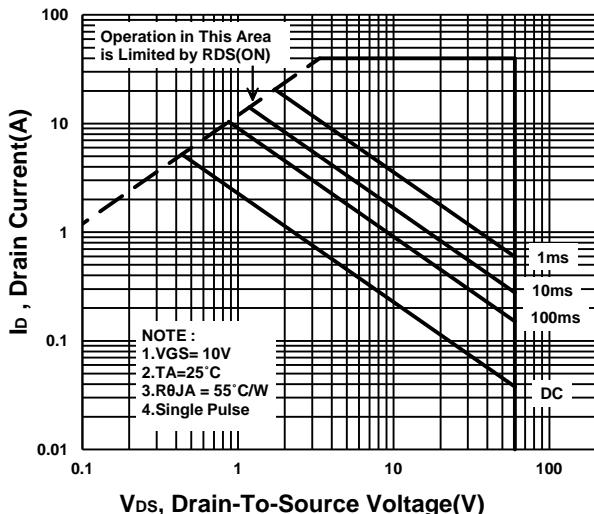


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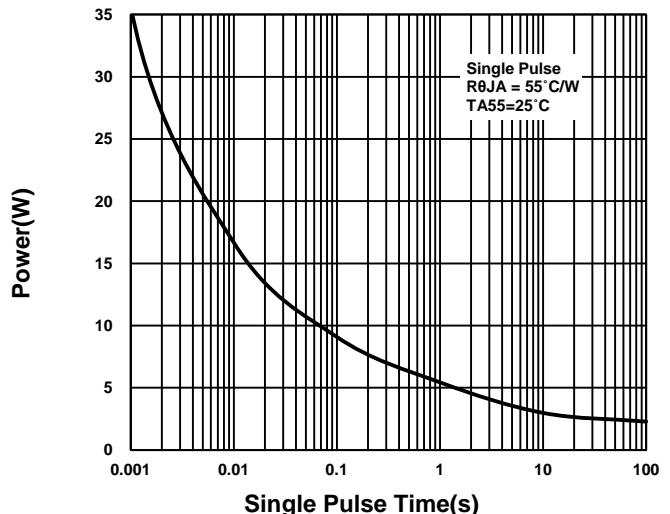
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Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

